

查询HMC241QS16_06供应商

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MICROWAVE CORPORATION v04.0404



HMC241QS16 / 241QS16E

GaAs MMIC SP4T NON-REFLECTIVE SWITCH, DC - 3.5 GHz

Typical Applications

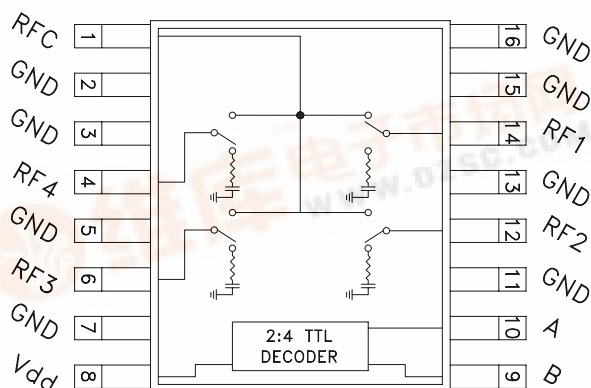
The HMC241QS16 & HMC241QS16E are ideal for:

- Base Stations & Portable Wireless
- CATV / DBS
- Wireless Local Loop
- Test Equipment

Features

- RoHS Compliant Product
- Low Insertion Loss (2 GHz): 0.5 dB
- Single Positive Supply: $V_{dd} = +5V$
- Integrated 2:4 TTL Decoder
- 16 Lead QSOP Package

Functional Diagram



General Description

The HMC241QS16 & HMC241QS16E are general purpose low-cost non-reflective SP4T switches in 16-lead QSOP packages. Covering DC - 3.5 GHz, this switch offers high isolation and has a low insertion loss of 0.5 dB at 2 GHz. The switch offers a single positive bias and true TTL/CMOS compatibility. A 2:4 decoder is integrated on the switch requiring only 2 control lines and a positive bias to select each path, replacing 8 control lines normally required by GaAs SP4T switches.

Electrical Specifications, $T_A = +25^\circ C$, For TTL Control and $V_{dd} = +5V$ in a 50 Ohm System

Parameter	Frequency	Min.	Typ.	Max.	Units
Insertion Loss	DC - 1.0 GHz		0.5	0.8	dB
	DC - 2.0 GHz		0.5	0.8	dB
	DC - 2.5 GHz		0.6	0.9	dB
	DC - 3.5 GHz		1.0	1.5	dB
Isolation	DC - 1.0 GHz	40	45		dB
	DC - 2.0 GHz	32	36		dB
	DC - 2.5 GHz	28	32		dB
	DC - 3.5 GHz	23	26		dB
Return Loss	DC - 2.5 GHz	17	21		dB
	DC - 3.5 GHz	9	12		dB
Return Loss	0.3 - 3.5 GHz	8	12		dB
	0.5 - 2.5 GHz	12	16		dB
Input Power for 1dB Compression	0.3 - 3.5 GHz	22	25		dBm
Input Third Order Intercept (Two-Tone Input Power = +7 dBm Each Tone)	0.3 - 3.5 GHz	40	44		dBm
Switching Characteristics	0.3 - 3.5 GHz		40		ns
			150		ns

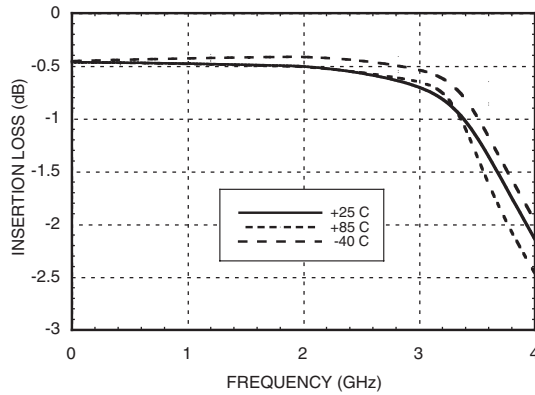
tRISE, tFALL (10/90% RF)
tON, tOFF (50% CTL to 10/90% RF)



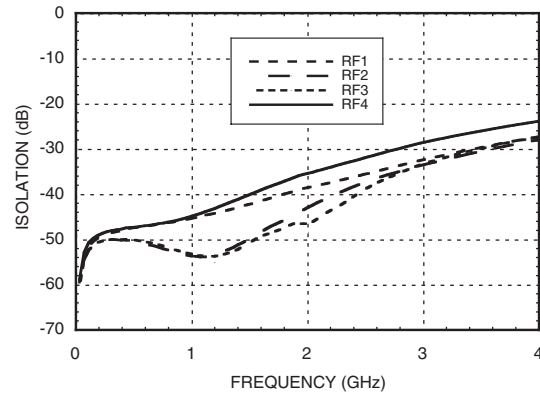
HMC241QS16 / 241QS16E

GaAs MMIC SP4T NON-REFLECTIVE SWITCH, DC - 3.5 GHz

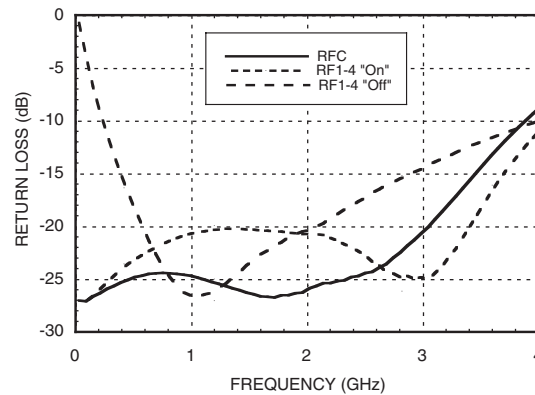
Insertion Loss



Isolation



Return Loss



Bias Voltage & Current

Vdd Range = +5.0 Vdc ± 10%		
Vdd (Vdc)	Idd (Typ.) (mA)	Idd (Max.) (mA)
+5.0	4.0	7.0

Truth Table

Control Input		Signal Path State
A	B	RFCOM to:
LOW	LOW	RF1
HIGH	LOW	RF2
LOW	HIGH	RF3
HIGH	HIGH	RF4

TTL/CMOS Control Voltages

State	Bias Condition
Low	0 to +0.8 Vdc @ 5uA Typ.
High	+2.0 to +5.0 Vdc @ 70 uA Typ.

NOTE:

DC Blocking capacitors are required at ports RFC and RF1, 2, 3, 4.



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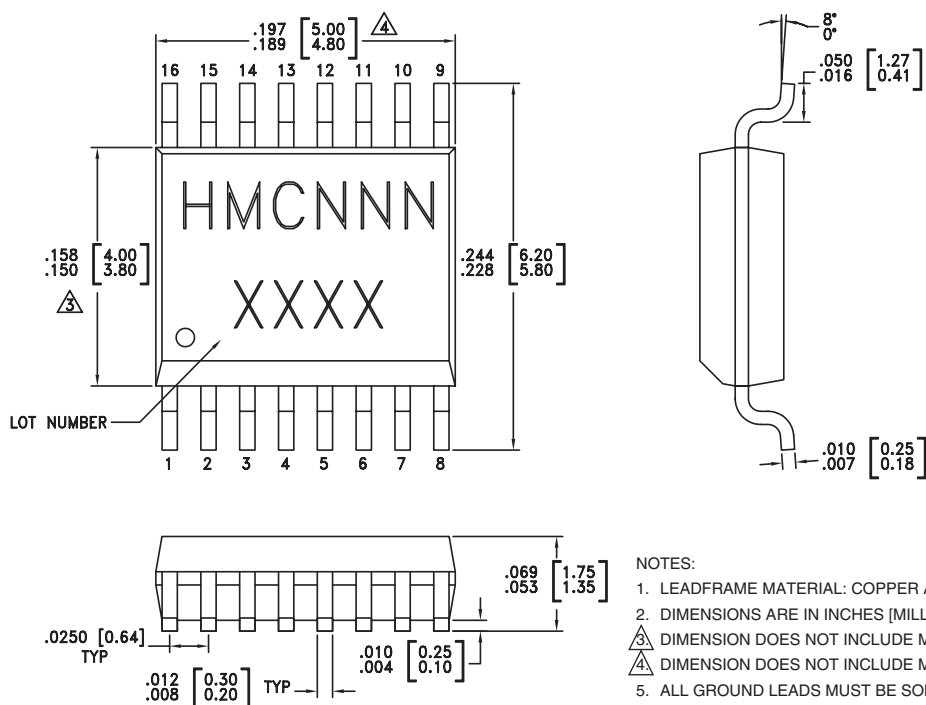
GaAs MMIC SP4T NON-REFLECTIVE
SWITCH, DC - 3.5 GHz

Absolute Maximum Ratings

Bias Voltage Range (Port Vdd)	+7.0 Vdc
Control Voltage Range (A & B)	-0.5V to Vdd +1 Vdc
Channel Temperature	150 °C
Thermal Resistance (Insertion Loss Path)	210 °C/W
Thermal Resistance (Terminated Path)	250 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
Maximum Input Power Vdd = +5 Vdc	+20 dBm (0.05 - 0.5 GHz) +27 dBm (0.5 - 3.5 GHz)

ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Outline Drawing



NOTES:

1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS].
3. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
4. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Leadframe Plating	MSL Rating	Package Marking ^[3]
HMC241QS16	Low Stress Injection Molded Plastic Silica and Silicon Impregnated	Sn/Pb Solder	MSL1 ^[1]	HMC241 XXXX
HMC241QS16E	RoHS-compliant Low Stress Injection Molded Plastic Silica and Silicon Impregnated	100% Matte Tin	MSL1 ^[2]	HMC241 XXXX

[1] Max peak reflow temperature of 235 °C

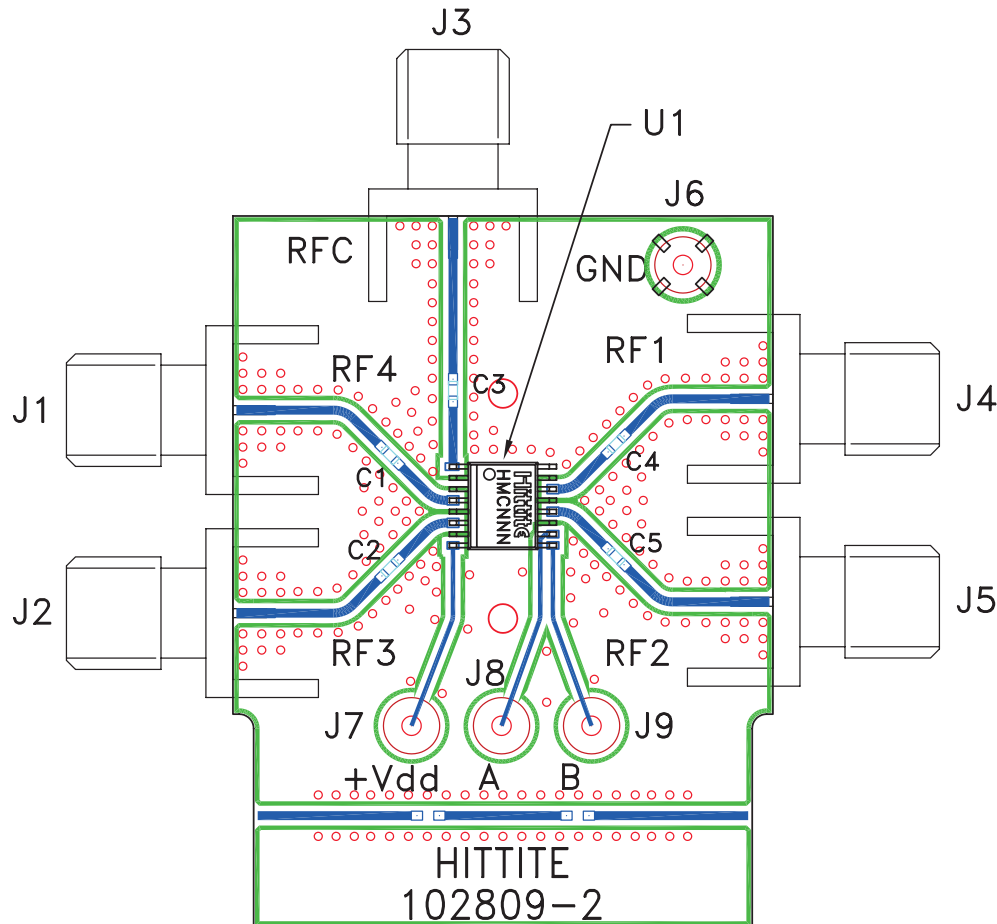
[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

HMC241QS16 / 241QS16E

**GaAs MMIC SP4T NON-REFLECTIVE
SWITCH, DC - 3.5 GHz**

Evaluation PCB



List of Materials for Evaluation PCB 102913 ^[1]

Item	Description
J1 - J5	PCB Mount SMA RF Connector
J6 - J9	DC Pin
C1 - C5	330 pF capacitor, 0402 Pkg.
U1	HMC241QS16 / HMC241QS16E SP4T Switch
PCB ^[2]	102809 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 ohm impedance and the package ground leads should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.